Zener Voltage Regulators

200 mW Micro Packaged

NZD5V1MU Series

This Zener diode is designed to provide voltage regulation protection and is especially attractive in situations where space is at a premium. Because of its small size, it is suited for use in mobile applications.

Specification Features:

- Standard Zener Breakdown Voltage Range: 2.2 V to 9.1 V
- Steady State Power Rating of 200 mW
- Small Body Outline Dimensions: 0.60 mm x 0.30 mm
- Low Body Height: 0.30 mm
- ESD Rating of Class 3 (>8 kV) per Human Body Model
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Mechanical Characteristics: MOUNTING POSITION: Any **QUALIFIED MAX REFLOW TEMPERATURE: 260°C Device Meets MSL 1 Requirements**

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Total Device Dissipation FR–5 Board, (Note 1) @ $T_A = 25^{\circ}C$	P _D	200	mW
Thermal Resistance from Junction-to-Ambient	$R_{\theta JA}$	400	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	–55 to +150	°C
Lead Solder Temperature – Maximum (10 Second Duration)	ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. $FR-5 = 1.0 \times 0.75 \times 0.62$ in.



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X3DFN2 CASE 152AF



X = Specific Device Code М = Month Code

ORDERING INFORMATION

Devic	e	Package	Shipping†
NZDxxxMU	T5G	X3DFN (Pb-Free)	10000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

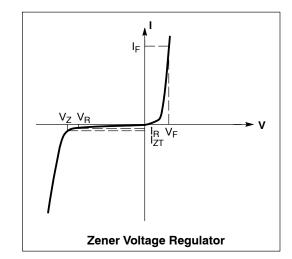
DEVICE MARKING INFORMATION

See specific marking information in the device marking column of the Electrical Characteristics tables starting on page 3 of this data sheet.

ELECTRICAL CHARACTERISTICS

 $(T_A = 25^{\circ}C \text{ unless otherwise noted}, V_F = 1.1 V Max. @ I_F = 10 mA for all types)$

Symbol	Parameter
VZ	Reverse Zener Voltage @ I _{ZT}
I _{ZT}	Reverse Current
Z _{ZT}	Maximum Zener Impedance @ I _{ZT}
I _{ZK}	Reverse Current
Z _{ZK}	Maximum Zener Impedance @ I _{ZK}
I _R	Reverse Leakage Current @ V _R
V _R	Reverse Voltage
١ _F	Forward Current
V _F	Forward Voltage @ I _F
ΘV _Z	Maximum Temperature Coefficient of V_Z
С	Max. Capacitance $@V_R = 0$ and $f = 1$ MHz



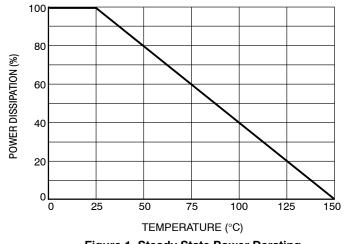


Figure 1. Steady State Power Derating

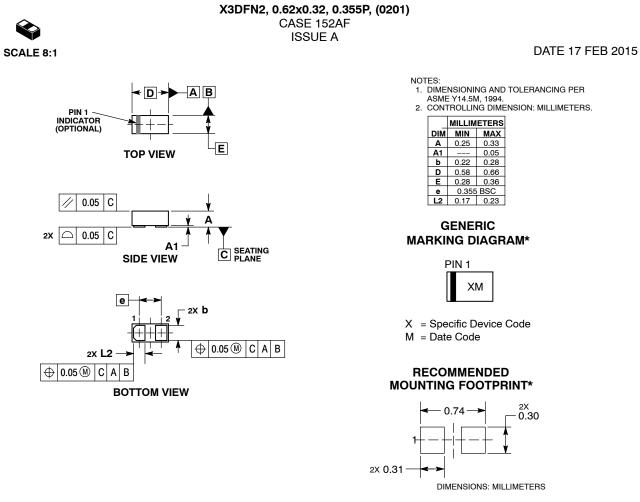
NZD5V1MU Series

		Zener Voltage (Note 1)			Zener Impedance			Leakage	Current			с
	Device	V _Z (Volts)		@ I _{ZT}	Z _{ZT} @ I _{ZT}	Z _{ZK} @ I _{ZK}		I _R @ V _R		ΘV _Z (mV/k) @ I _{ZT}		@ V _R = 0 f = 1 MHz
Device	Marking	Min	Max	mA	Ω	Ω	mA	μΑ	Volts	Min	Max	pF
NZD2V2MUT5G	K*	2.08	2.30	4	100	1000	1	50	1	-3.5	0	210
NZD2V4MUT5G	D***	2.28	2.52	5	100	1000	1	50	1	-3.5	0	210
NZD2V7MUT5G	E***	2.57	2.84	5	100	1000	1	20	1	-3.5	0	210
NZD3V0MUT5G	Q*	2.85	3.15	5	100	1000	1	10	1	-3.5	0	210
NZD3V3MUT5G	F***	3.14	3.47	5	100	1000	1	10	1	-3.5	0	210
NZD3V6MUT5G	J***	3.42	3.78	5	100	1000	1	10	1	-3.5	0	210
NZD3V9MUT5G	L	3.71	4.10	5	100	1000	1	5	1	-3.5	-2.5	210
NZD4V3MUT5G	D**	4.09	4.52	5	100	1000	1	5	1	-3.5	0	210
NZD4V7MUT5G	Р	4.47	4.94	5	100	800	0.5	2	1	-3.5	0.2	150
NZD5V1MUT5G	Q	4.85	5.36	5	80	500	0.5	2	1.5	-2.7	1.2	130
NZD5V6MUT5G	R	5.32	5.88	5	60	200	0.5	1	2.5	-2.0	2.5	115
NZD6V2MUT5G	Т	5.89	6.51	5	60	100	0.5	1	3.0	0.4	3.7	110
NZD6V8MUT5G	K***	6.46	7.14	5	40	60	0.5	0.5	3.5	1.2	4.5	105
NZD7V5MUT5G	L***	7.13	7.88	5	30	60	0.5	0.5	4.0	2.5	5.3	100
NZD8V2MUT5G	2	7.79	8.61	5	30	60	0.5	0.5	5.0	3.2	6.2	90
NZD9V1MUT5G	E**	8.65	9.56	5	30	60	0.5	0.5	6.0	3.8	7.0	80

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted, V_F = 1.1 V Max. @ I_F = 10 mA for all types)

*Rotated 90°. **Rotated 180°. ***Rotated 270°. 1. Zener voltage is measured with a pulse test current I_Z at an ambient temperature of 25°C.





See Application Note AND8398/D for more mounting details

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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